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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	8051
Core Size	8-Bit
Speed	25MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	15
Program Memory Size	4KB (4K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	2.2V ~ 3.6V
Data Converters	A/D 15x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	20-WFQFN Exposed Pad
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051f851-c-im

Table 1.2. Power Consumption (Continued)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
ADC0 Burst Mode, 10-bit single conversions, internal reference, Low power bias settings	I_{ADC}	200 ksps, V_{DD} = 3.0 V	—	490	—	µA
		100 ksps, V_{DD} = 3.0 V	—	245	—	µA
		10 ksps, V_{DD} = 3.0 V	—	23	—	µA
ADC0 Burst Mode, 12-bit single conversions, external reference	I_{ADC}	100 ksps, V_{DD} = 3.0 V	—	530	—	µA
		50 ksps, V_{DD} = 3.0 V	—	265	—	µA
		10 ksps, V_{DD} = 3.0 V	—	53	—	µA
ADC0 Burst Mode, 12-bit single conversions, internal reference	I_{ADC}	100 ksps, V_{DD} = 3.0 V, Normal bias	—	950	—	µA
		50 ksps, V_{DD} = 3.0 V, Low power bias	—	420	—	µA
		10 ksps, V_{DD} = 3.0 V, Low power bias	—	85	—	µA
Internal ADC0 Reference, Always-on[5]	I_{IREF}	Normal Power Mode	—	680	790	µA
		Low Power Mode	—	160	210	µA
Temperature Sensor	I_{TSENSE}		—	75	120	µA
Comparator 0 (CMP0), Comparator 1 (CMP1)	I_{CMP}	CPnMD = 11	—	0.5	—	µA
		CPnMD = 10	—	3	—	µA
		CPnMD = 01	—	10	—	µA
		CPnMD = 00	—	25	—	µA
Voltage Supply Monitor (VMON0)	I_{VMON}		—	15	20	µA

Notes:

1. Currents are additive. For example, where I_{DD} is specified and the mode is not mutually exclusive, enabling the functions increases supply current by the specified amount.
2. Includes supply current from internal regulator, supply monitor, and High Frequency Oscillator.
3. Includes supply current from internal regulator, supply monitor, and Low Frequency Oscillator.
4. ADC0 always-on power excludes internal reference supply current.
5. The internal reference is enabled as-needed when operating the ADC in burst mode to save power.

2.5. Communications and other Digital Peripherals

2.5.1. Universal Asynchronous Receiver/Transmitter (UART0)

The UART uses two signals (TX and RX) and a predetermined fixed baud rate to provide asynchronous communications with other devices.

The UART module provides the following features:

- Asynchronous transmissions and receptions.
- Baud rates up to SYSCLK / 2 (transmit) or SYSCLK / 8 (receive).
- 8- or 9-bit data.
- Automatic start and stop generation.

2.5.2. Serial Peripheral Interface (SPI0)

SPI is a 3- or 4-wire communication interface that includes a clock, input data, output data, and an optional select signal.

The SPI module includes the following features:

- Supports 3- or 4-wire master or slave modes.
- Supports external clock frequencies up to SYSCLK / 2 in master mode and SYSCLK / 10 in slave mode.
- Support for all clock phase and polarity modes.
- 8-bit programmable clock rate.
- Support for multiple masters on the same data lines.

2.5.3. System Management Bus / I2C (SMBus0)

The SMBus interface is a two-wire, bi-directional serial bus compatible with both I2C and SMBus protocols. The two clock and data signals operate in open-drain mode with external pull-ups to support automatic bus arbitration.

Reads and writes to the interface are byte-oriented with the SMBus interface autonomously controlling the serial transfer of the data. Data can be transferred at up to 1/8th of the system clock as a master or slave, which can be faster than allowed by the SMBus / I2C specification, depending on the clock source used. A method of extending the clock-low duration is available to accommodate devices with different speed capabilities on the same bus.

The SMBus interface may operate as a master and/or slave, and may function on a bus with multiple masters. The SMBus provides control of SDA (serial data), SCL (serial clock) generation and synchronization, arbitration logic, and start/stop control and generation.

The SMBus module includes the following features:

- Standard (up to 100 kbps) and Fast (400 kbps) transfer speeds.
- Support for master, slave, and multi-master modes.
- Hardware synchronization and arbitration for multi-master mode.
- Clock low extending (clock stretching) to interface with faster masters.
- Hardware support for 7-bit slave and general call address recognition.
- Firmware support for 10-bit slave address decoding.
- Ability to inhibit all slave states.
- Programmable data setup/hold times.

2.5.4. 16/32-bit CRC (CRC0)

The CRC module is designed to provide hardware calculations for flash memory verification and communications protocols. The CRC module supports the standard CCITT-16 16-bit polynomial (0x1021), and includes the following features:

- Support for four CCITT-16 polynomial.

Table 3.1. Pin Definitions for C8051F850/1/2/3/4/5-GU and C8051F850/1/2/3/4/5-IU

Pin Name	Type	Pin Numbers	Crossbar Capability	Additional Digital Functions	Analog Functions
P0.0	Standard I/O	4	Yes	P0MAT.0 INT0.0 INT1.0	ADC0.0 CP0P.0 CP0N.0 VREF
P0.1	Standard I/O	3	Yes	P0MAT.1 INT0.1 INT1.1	ADC0.1 CP0P.1 CP0N.1 AGND
P0.2	Standard I/O	2	Yes	P0MAT.2 INT0.2 INT1.2	ADC0.2 CP0P.2 CP0N.2
P0.3 / EXTCLK	Standard I/O / External CMOS Clock Input	23	Yes	P0MAT.3 EXTCLK INT0.3 INT1.3	ADC0.3 CP0P.3 CP0N.3
P0.4	Standard I/O	22	Yes	P0MAT.4 INT0.4 INT1.4	ADC0.4 CP0P.4 CP0N.4
P0.5	Standard I/O	21	Yes	P0MAT.5 INT0.5 INT1.5	ADC0.5 CP0P.5 CP0N.5
P0.6	Standard I/O	20	Yes	P0MAT.6 CNVSTR INT0.6 INT1.6	ADC0.6 CP0P.6 CP0N.6
P0.7	Standard I/O	19	Yes	P0MAT.7 INT0.7 INT1.7	ADC0.7 CP0P.7 CP0N.7

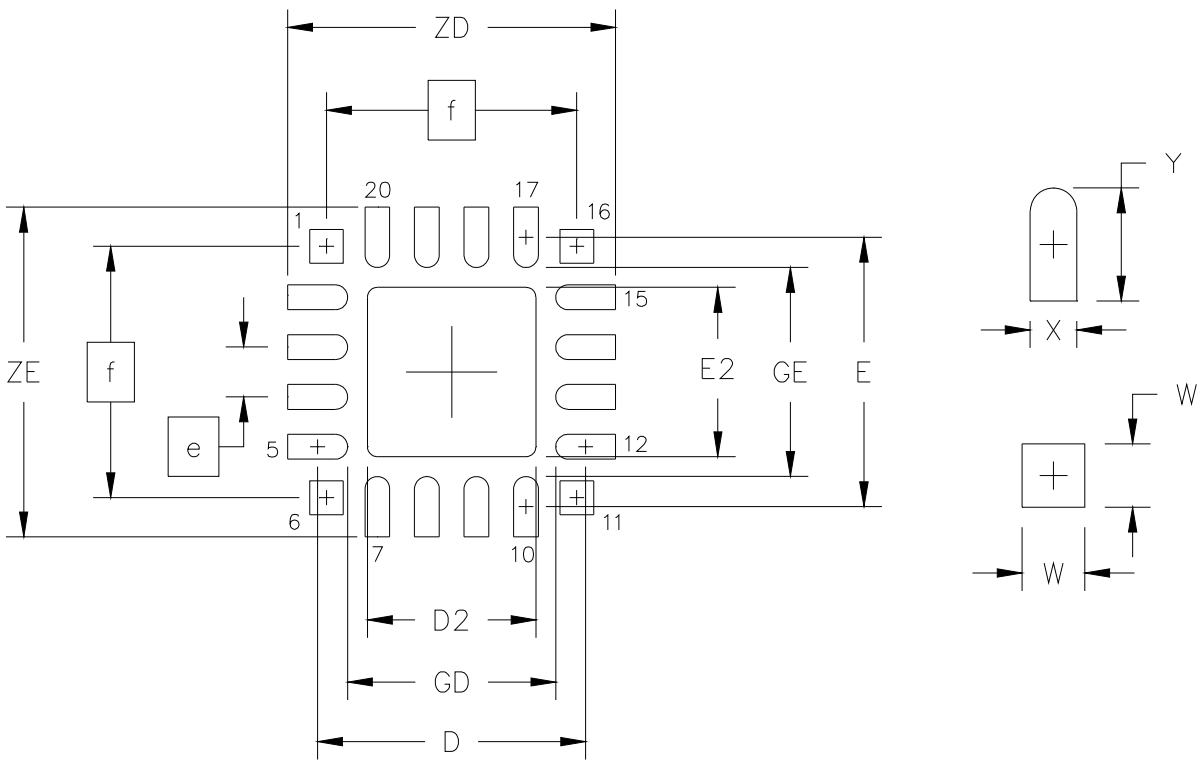

Figure 6.2. QFN-20 Landing Diagram

Table 9.2. Special Function Registers (Continued)

Register	Address	Register Description	Page
IE	0xA8	Interrupt Enable	75
IP	0xB8	Interrupt Priority	77
IT01CF	0xE4	INT0 / INT1 Configuration	150
OSCICL	0xC7	High Frequency Oscillator Calibration	127
OSCLCN	0xB1	Low Frequency Oscillator Control	128
P0	0x80	Port 0 Pin Latch	199
P0MASK	0xFE	Port 0 Mask	197
P0MAT	0xFD	Port 0 Match	198
P0MDIN	0xF1	Port 0 Input Mode	200
P0MDOUT	0xA4	Port 0 Output Mode	201
P0SKIP	0xD4	Port 0 Skip	202
P1	0x90	Port 1 Pin Latch	205
P1MASK	0xEE	Port 1 Mask	203
P1MAT	0xED	Port 1 Match	204
P1MDIN	0xF2	Port 1 Input Mode	206
P1MDOUT	0xA5	Port 1 Output Mode	207
P1SKIP	0xD5	Port 1 Skip	208
P2	0xA0	Port 2 Pin Latch	209
P2MDOUT	0xA6	Port 2 Output Mode	210
PCA0CENT	0x9E	PCA Center Alignment Enable	177
PCA0CLR	0x9C	PCA Comparator Clear Control	170
PCA0CN	0xD8	PCA Control	167
PCA0CPH0	0xFC	PCA Capture Module High Byte 0	175
PCA0CPH1	0xEA	PCA Capture Module High Byte 1	181
PCA0CPH2	0xEC	PCA Capture Module High Byte 2	183
PCA0CPL0	0xFB	PCA Capture Module Low Byte 0	174
PCA0CPL1	0xE9	PCA Capture Module Low Byte 1	180
PCA0CPL2	0xEB	PCA Capture Module Low Byte 2	182

10. Flash Memory

On-chip, re-programmable flash memory is included for program code and non-volatile data storage. The flash memory is organized in 512-byte pages. It can be erased and written through the C2 interface or from firmware by overloading the MOVX instruction. Any individual byte in flash memory must only be written once between page erase operations.

10.1. Security Options

The CIP-51 provides security options to protect the flash memory from inadvertent modification by software as well as to prevent the viewing of proprietary program code and constants. The Program Store Write Enable (bit PSWE in register PSCTL) and the Program Store Erase Enable (bit PSEE in register PSCTL) bits protect the flash memory from accidental modification by software. PSWE must be explicitly set to '1' before software can modify the flash memory; both PSWE and PSEE must be set to '1' before software can erase flash memory. Additional security features prevent proprietary program code and data constants from being read or altered across the C2 interface.

A Security Lock Byte located in flash user space offers protection of the flash program memory from access (reads, writes, or erases) by unprotected code or the C2 interface. See Section "8. Memory Organization" on page 52 for the location of the security byte. The flash security mechanism allows the user to lock *n* 512-byte flash pages, starting at page 0 (addresses 0x0000 to 0x01FF), where *n* is the 1's complement number represented by the Security Lock Byte. **Note that the page containing the flash Security Lock Byte is unlocked when no other flash pages are locked (all bits of the Lock Byte are '1') and locked when any other flash pages are locked (any bit of the Lock Byte is '0').** An example is shown in Figure 10.1.

Security Lock Byte:	11111101b
1s Complement:	00000010b
Flash pages locked:	3 (First two flash pages + Lock Byte Page)

Figure 10.1. Security Byte Decoding

The level of flash security depends on the flash access method. The three flash access methods that can be restricted are reads, writes, and erases from the C2 debug interface, user firmware executing on unlocked pages, and user firmware executing on locked pages. Table 10.1 summarizes the flash security features of the C8051F85x/86x devices.

Table 10.1. Flash Security Summary

Action	C2 Debug Interface	User Firmware executing from:	
		an unlocked page	a locked page
Read, Write or Erase unlocked pages (except page with Lock Byte)	Permitted	Permitted	Permitted
Read, Write or Erase locked pages (except page with Lock Byte)	Not Permitted	Flash Error Reset	Permitted
Read or Write page containing Lock Byte (if no pages are locked)	Permitted	Permitted	N/A
Read or Write page containing Lock Byte (if any page is locked)	Not Permitted	Flash Error Reset	Permitted

Register 10.2. FLKEY: Flash Lock and Key

Bit	7	6	5	4	3	2	1	0
Name	FLKEY							
Type	RW							
Reset	0	0	0	0	0	0	0	0
SFR Address: 0xB7								

Table 10.3. FLKEY Register Bit Descriptions

Bit	Name	Function
7:0	FLKEY	**Flash Lock and Key Register.** Write: This register provides a lock and key function for flash erasures and writes. Flash writes and erases are enabled by writing 0xA5 followed by 0xF1 to the FLKEY register. Flash writes and erases are automatically disabled after the next write or erase is complete. If any writes to FLKEY are performed incorrectly, or if a flash write or erase operation is attempted while these operations are disabled, the flash will be permanently locked from writes or erasures until the next device reset. If an application never writes to flash, it can intentionally lock the flash by writing a non-0xA5 value to FLKEY from software. Read: When read, bits 1-0 indicate the current flash lock state. 00: Flash is write/erase locked. 01: The first key code has been written (0xA5). 10: Flash is unlocked (writes/erases allowed). 11: Flash writes/erases are disabled until the next reset.

11.1. Device Identification Registers

Register 11.1. DEVICEID: Device Identification

Bit	7	6	5	4	3	2	1	0
Name	DEVICEID							
Type	R							
Reset	0	0	1	1	0	0	0	0
SFR Address: 0xB5								

Table 11.2. DEVICEID Register Bit Descriptions

Bit	Name	Function
7:0	DEVICEID	**Device ID.** This read-only register returns the 8-bit device ID: 0x30 (C8051F85x/86x).

12. Interrupts

The C8051F85x/86x includes an extended interrupt system supporting multiple interrupt sources with two priority levels. The allocation of interrupt sources between on-chip peripherals and external input pins varies according to the specific version of the device. Each interrupt source has one or more associated interrupt-pending flag(s) located in an SFR. When a peripheral or external source meets a valid interrupt condition, the associated interrupt-pending flag is set to logic 1.

If interrupts are enabled for the source, an interrupt request is generated when the interrupt-pending flag is set. As soon as execution of the current instruction is complete, the CPU generates an LCALL to a predetermined address to begin execution of an interrupt service routine (ISR). Each ISR must end with an RETI instruction, which returns program execution to the next instruction that would have been executed if the interrupt request had not occurred. If interrupts are not enabled, the interrupt-pending flag is ignored by the hardware and program execution continues as normal. The interrupt-pending flag is set to logic 1 regardless of the interrupt's enable/disable state.

Each interrupt source can be individually enabled or disabled through the use of an associated interrupt enable bit in an SFR (IE and EIE1). However, interrupts must first be globally enabled by setting the EA bit in the IE register to logic 1 before the individual interrupt enables are recognized. Setting the EA bit to logic 0 disables all interrupt sources regardless of the individual interrupt-enable settings.

Some interrupt-pending flags are automatically cleared by the hardware when the CPU vectors to the ISR. However, most are not cleared by the hardware and must be cleared by software before returning from the ISR. If an interrupt-pending flag remains set after the CPU completes the return-from-interrupt (RETI) instruction, a new interrupt request will be generated immediately and the CPU will re-enter the ISR after the completion of the next instruction.

12.1. MCU Interrupt Sources and Vectors

The C8051F85x/86x MCUs support interrupt sources for each peripheral on the device. Software can simulate an interrupt by setting any interrupt-pending flag to logic 1. If interrupts are enabled for the flag, an interrupt request will be generated and the CPU will vector to the ISR address associated with the interrupt-pending flag. MCU interrupt sources, associated vector addresses, priority order and control bits are summarized in Table 12.1. Refer to the datasheet section associated with a particular on-chip peripheral for information regarding valid interrupt conditions for the peripheral and the behavior of its interrupt-pending flag(s).

12.1.1. Interrupt Priorities

Each interrupt source can be individually programmed to one of two priority levels: low or high. A low priority interrupt service routine can be preempted by a high priority interrupt. A high priority interrupt cannot be preempted. Each interrupt has an associated interrupt priority bit in an SFR (IP or EIP1) used to configure its priority level. Low priority is the default. If two interrupts are recognized simultaneously, the interrupt with the higher priority is serviced first. If both interrupts have the same priority level, a fixed priority order is used to arbitrate, given in Table 12.1.

12.1.2. Interrupt Latency

Interrupt response time depends on the state of the CPU when the interrupt occurs. Pending interrupts are sampled and priority decoded each system clock cycle. Therefore, the fastest possible response time is 5 system clock cycles: 1 clock cycle to detect the interrupt and 4 clock cycles to complete the LCALL to the ISR. If an interrupt is pending when a RETI is executed, a single instruction is executed before an LCALL is made to service the pending interrupt. Therefore, the maximum response time for an interrupt (when no other interrupt is currently being serviced or the new interrupt is of greater priority) occurs when the CPU is performing an RETI instruction followed by a DIV as the next instruction. In this case, the response time is 18 system clock cycles: 1 clock cycle to detect the interrupt, 5 clock cycles to execute the RETI, 8 clock

Register 14.3. ADC0CF: ADC0 Configuration

Bit	7	6	5	4	3	2	1	0
Name	ADSC					AD8BE	ADTM	ADGN
Type	RW					RW	RW	RW
Reset	1	1	1	1	1	0	0	0
SFR Address: 0xBC								

Table 14.6. ADC0CF Register Bit Descriptions

Bit	Name	Function
7:3	ADSC	**SAR Clock Divider.** This field sets the ADC clock divider value. It should be configured to be as close to the maximum SAR clock speed as the datasheet will allow. The SAR clock frequency is given by the following equation: $F_{CLKSAR} = \frac{F_{ADCCLK}}{ADSC + 1}$ F_{ADCCLK} is equal to the selected SYSCLK when ADBMEN is 0 and the high-frequency oscillator when ADBMEN is 1.
2	AD8BE	**8-Bit Mode Enable.** 0: ADC0 operates in 10-bit or 12-bit mode (normal operation). 1: ADC0 operates in 8-bit mode.
1	ADTM	**Track Mode.** Selects between Normal or Delayed Tracking Modes. 0: Normal Track Mode. When ADC0 is enabled, conversion begins immediately following the start-of-conversion signal. 1: Delayed Track Mode. When ADC0 is enabled, conversion begins 4 SAR clock cycles following the start-of-conversion signal. The ADC is allowed to track during this time.
0	ADGN	**Gain Control.** 0: The on-chip PGA gain is 0.5. 1: The on-chip PGA gain is 1.

Table 17.1. CMP0 Positive Input Multiplexer Channels

CMXP Setting in Register CPT0MX	Signal Name	QSOP24 Pin Name	QFN20 Pin Name	SOIC16 Pin Name
0000	CP0P.0	P0.0	P0.0	P0.0
0001	CP0P.1	P0.1	P0.1	P0.1
0010	CP0P.2	P0.2	P0.2	P0.2
0011	CP0P.3	P0.3	P0.3	P0.3
0100	CP0P.4	P0.4	P0.4	P0.4
0101	CP0P.5	P0.5	P0.5	P0.5
0110	CP0P.6	P0.6	P0.6	Reserved
0111	CP0P.7	P0.7	P0.7	Reserved
1000	LDO	Internal 1.8 V LDO Output		
1001-1111	None	No connection		

Table 17.2. CMP0 Negative Input Multiplexer Channels

CMXN Setting in Register CPT0MX	Signal Name	QSOP24 Pin Name	QFN20 Pin Name	SOIC16 Pin Name
0000	CP0N.0	P0.0	P0.0	P0.0
0001	CP0N.1	P0.1	P0.1	P0.1
0010	CP0N.2	P0.2	P0.2	P0.2
0011	CP0N.3	P0.3	P0.3	P0.3
0100	CP0N.4	P0.4	P0.4	P0.4
0101	CP0N.5	P0.5	P0.5	P0.5
0110	CP0N.6	P0.6	P0.6	Reserved
0111	CP0N.7	P0.7	P0.7	Reserved
1000	GND	GND		
1001-1111	None	No connection		

18. Cyclic Redundancy Check Unit (CRC0)

C8051F85x/86x devices include a cyclic redundancy check unit (CRC0) that can perform a CRC using a 16-bit polynomial. CRC0 accepts a stream of 8-bit data written to the CRC0IN register. CRC0 posts the 16-bit result to an internal register. The internal result register may be accessed indirectly using the CRCPNT bits and CRC0DAT register, as shown in Figure 18.1. CRC0 also has a bit reverse register for quick data manipulation.

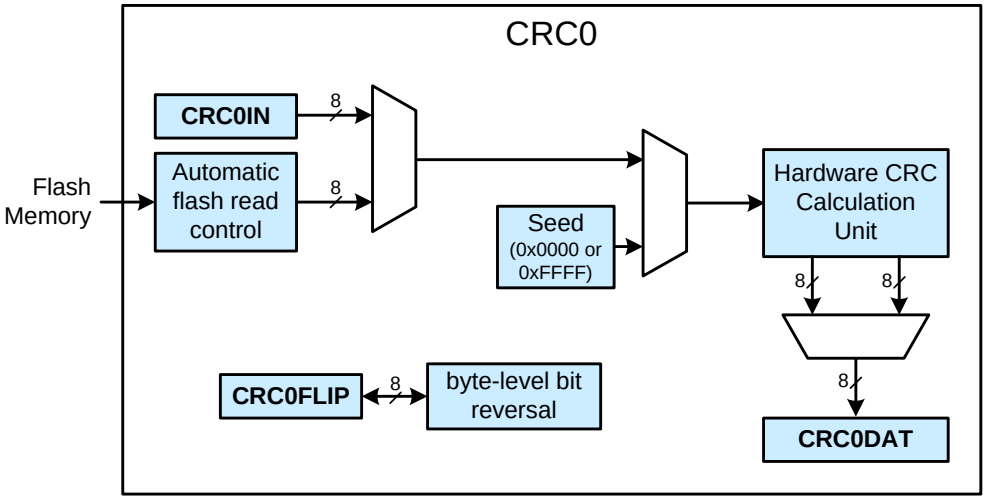

Figure 18.1. CRC0 Block Diagram

18.1. CRC Algorithm

The CRC unit generates a CRC result equivalent to the following algorithm:

1. XOR the input with the most-significant bits of the current CRC result. If this is the first iteration of the CRC unit, the current CRC result will be the set initial value (0x0000 or 0xFFFF).

2a. If the MSB of the CRC result is set, shift the CRC result and XOR the result with the selected polynomial.

2b. If the MSB of the CRC result is not set, shift the CRC result.

Repeat Steps 2a/2b for the number of input bits (8). The algorithm is also described in the following example.

18.2. Preparing for a CRC Calculation

To prepare CRC0 for a CRC calculation, software should set the initial value of the result. The polynomial used for the CRC computation is 0x1021. The CRC0 result may be initialized to one of two values: 0x0000 or 0xFFFF. The following steps can be used to initialize CRC0.

1. Select the initial result value (Set CRCVAL to 0 for 0x0000 or 1 for 0xFFFF).
2. Set the result to its initial value (Write 1 to CRCINIT).

18.3. Performing a CRC Calculation

Once CRC0 is initialized, the input data stream is sequentially written to CRC0IN, one byte at a time. The CRC0 result is automatically updated after each byte is written. The CRC engine may also be configured to automatically perform a CRC on one or more 256 byte blocks read from flash. The following steps can be used to automatically perform a CRC on flash memory.

1. Prepare CRC0 for a CRC calculation as shown above.
2. Write the index of the starting page to CRC0AUTO.
3. Set the AUTOEN bit to 1 in CRC0AUTO.
4. Write the number of 256 byte blocks to perform in the CRC calculation to CRCCNT.
5. Write any value to CRC0CN (or OR its contents with 0x00) to initiate the CRC calculation. The CPU will not execute code any additional code until the CRC operation completes. See the note in the CRC0CN register definition for more information on how to properly initiate a CRC calculation.
6. Clear the AUTOEN bit in CRC0AUTO.
7. Read the CRC result.

18.4. Accessing the CRC0 Result

The internal CRC0 result is 16 bits. The CRCPNT bits select the byte that is targeted by read and write operations on CRC0DAT and increment after each read or write. The calculation result will remain in the internal CR0 result register until it is set, overwritten, or additional data is written to CRC0IN.

18.5. CRC0 Bit Reverse Feature

CRC0 includes hardware to reverse the bit order of each bit in a byte as shown in Figure 18.2. Each byte of data written to CRC0FLIP is read back bit reversed. For example, if 0xC0 is written to CRC0FLIP, the data read back is 0x03. Bit reversal is a useful mathematical function used in algorithms such as the FFT.

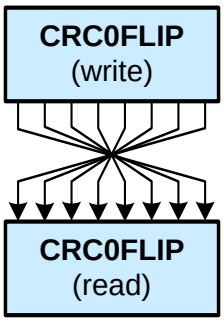

Figure 18.2. Bit Reversal

18.6. CRC Control Registers

Register 18.1. CRC0CN: CRC0 Control

Bit	7	6	5	4	3	2	1	0
Name	Reserved				CRCINIT	CRCVAL	Reserved	CRCPNT
Type	R				RW	RW	R	RW
Reset	0	0	0	1	0	0	0	0
SFR Address: 0xCE								

Table 18.2. CRC0CN Register Bit Descriptions

Bit	Name	Function
7:4	Reserved	Must write reset value.
3	CRCINIT	**CRC Result Initialization Bit.** Writing a 1 to this bit initializes the entire CRC result based on CRCVAL.
2	CRCVAL	**CRC Set Value Initialization Bit.** This bit selects the set value of the CRC result. 0: CRC result is set to 0x0000 on write of 1 to CRCINIT. 1: CRC result is set to 0xFFFF on write of 1 to CRCINIT.
1	Reserved	Must write reset value.
0	CRCPNT	**CRC Result Pointer.** Specifies the byte of the CRC result to be read/written on the next access to CRC0DAT. This bit will automatically toggle upon each read or write. 0: CRC0DAT accesses bits 7-0 of the 16-bit CRC result. 1: CRC0DAT accesses bits 15-8 of the 16-bit CRC result.
Note: Upon initiation of an automatic CRC calculation, the three cycles following a write to CRC0CN that initiate a CRC operation must only contain instructions which execute in the same number of cycles as the number of bytes in the instruction. An example of such an instruction is a 3-byte MOV that targets the CRC0FLIP register. When programming in C, the dummy value written to CRC0FLIP should be a non-zero value to prevent the compiler from generating a 2-byte MOV instruction.		

disable the comparison, and prevent the match edge from occuring. Note that although the PCA0CPn compare register determines the duty cycle, it is not always appropriate for firmware to update this register directly. See the sections on 8 to 11-bit and 16-bit PWM mode for additional details on adjusting duty cycle in the various modes.

$$\text{Duty Cycle} = \frac{(2^N - \text{PCA0CPn})}{2^N}$$

Equation 20.2. N-bit Edge-Aligned PWM Duty Cycle With CEXnPOL = 0 (N = PWM resolution)

$$\text{Duty Cycle} = \frac{\text{PCA0CPn}}{2^N}$$

Equation 20.3. N-bit Edge-Aligned PWM Duty Cycle With CEXnPOL = 0 (N = PWM resolution)

Register 21.15. P1MDOUT: Port 1 Output Mode

Bit	7	6	5	4	3	2	1	0
Name	P1MDOUT							
Type	RW							
Reset	0	0	0	0	0	0	0	0
SFR Address: 0xA5								

Table 21.18. P1MDOUT Register Bit Descriptions

Bit	Name	Function
7:0	P1MDOUT	**Port 1 Output Mode.** These bits are only applicable when the pin is configured for digital mode using the P1MDIN register. 0: Corresponding P1.n Output is open-drain. 1: Corresponding P1.n Output is push-pull.
Note: Port 1 consists of 8 bits (P1.0-P1.7) on QSOP24 packages and 7 bits (P1.0-P1.6) on QFN20 packages and 4 bits (P1.0-P1.3) on SOIC16 packages.		

23.1. Signal Descriptions

The four signals used by SPI0 (MOSI, MISO, SCK, NSS) are described below.

23.1.1. Master Out, Slave In (MOSI)

The master-out, slave-in (MOSI) signal is an output from a master device and an input to slave devices. It is used to serially transfer data from the master to the slave. This signal is an output when SPI0 is operating as a master and an input when SPI0 is operating as a slave. Data is transferred most-significant bit first. When configured as a master, MOSI is driven by the MSB of the shift register in both 3- and 4-wire mode.

23.1.2. Master In, Slave Out (MISO)

The master-in, slave-out (MISO) signal is an output from a slave device and an input to the master device. It is used to serially transfer data from the slave to the master. This signal is an input when SPI0 is operating as a master and an output when SPI0 is operating as a slave. Data is transferred most-significant bit first. The MISO pin is placed in a high-impedance state when the SPI module is disabled and when the SPI operates in 4-wire mode as a slave that is not selected. When acting as a slave in 3-wire mode, MISO is always driven by the MSB of the shift register.

23.1.3. Serial Clock (SCK)

The serial clock (SCK) signal is an output from the master device and an input to slave devices. It is used to synchronize the transfer of data between the master and slave on the MOSI and MISO lines. SPI0 generates this signal when operating as a master. The SCK signal is ignored by a SPI slave when the slave is not selected (NSS = 1) in 4-wire slave mode.

23.1.4. Slave Select (NSS)

The function of the slave-select (NSS) signal is dependent on the setting of the NSSMD1 and NSSMD0 bits in the SPI0CN register. There are three possible modes that can be selected with these bits:

1. NSSMD[1:0] = 00: 3-Wire Master or 3-Wire Slave Mode: SPI0 operates in 3-wire mode, and NSS is disabled. When operating as a slave device, SPI0 is always selected in 3-wire mode. Since no select signal is present, SPI0 must be the only slave on the bus in 3-wire mode. This is intended for point-to-point communication between a master and one slave.
2. NSSMD[1:0] = 01: 4-Wire Slave or Multi-Master Mode: SPI0 operates in 4-wire mode, and NSS is enabled as an input. When operating as a slave, NSS selects the SPI0 device. When operating as a master, a 1-to-0 transition of the NSS signal disables the master function of SPI0 so that multiple master devices can be used on the same SPI bus.
3. NSSMD[1:0] = 1x: 4-Wire Master Mode: SPI0 operates in 4-wire mode, and NSS is enabled as an output. The setting of NSSMD0 determines what logic level the NSS pin will output. This configuration should only be used when operating SPI0 as a master device.

See Figure 23.2, Figure 23.3, and Figure 23.4 for typical connection diagrams of the various operational modes. **Note that the setting of NSSMD bits affects the pinout of the device.** When in 3-wire master or 3-wire slave mode, the NSS pin will not be mapped by the crossbar. In all other modes, the NSS signal will be mapped to a pin on the device.

STA and STO indicate that a START and/or STOP has been detected or generated since the last SMBus interrupt. STA and STO are also used to generate START and STOP conditions when operating as a master. Writing a 1 to STA will cause the SMBus interface to enter Master Mode and generate a START when the bus becomes free (STA is not cleared by hardware after the START is generated). Writing a 1 to STO while in Master Mode will cause the interface to generate a STOP and end the current transfer after the next ACK cycle. If STO and STA are both set (while in Master Mode), a STOP followed by a START will be generated.

The ARBLOST bit indicates that the interface has lost an arbitration. This may occur anytime the interface is transmitting (master or slave). A lost arbitration while operating as a slave indicates a bus error condition. ARBLOST is cleared by hardware each time SI is cleared.

The SI bit (SMBus Interrupt Flag) is set at the beginning and end of each transfer, after each byte frame, or when an arbitration is lost; see Table 24.3 for more details.

Important Note About the SI Bit: The SMBus interface is stalled while SI is set; thus SCL is held low, and the bus is stalled until software clears SI.

24.4.4.1. Software ACK Generation

When the EHACK bit in register SMB0ADM is cleared to 0, the firmware on the device must detect incoming slave addresses and ACK or NACK the slave address and incoming data bytes. As a receiver, writing the ACK bit defines the outgoing ACK value; as a transmitter, reading the ACK bit indicates the value received during the last ACK cycle. ACKRQ is set each time a byte is received, indicating that an outgoing ACK value is needed. When ACKRQ is set, software should write the desired outgoing value to the ACK bit before clearing SI. A NACK will be generated if software does not write the ACK bit before clearing SI. SDA will reflect the defined ACK value immediately following a write to the ACK bit; however SCL will remain low until SI is cleared. If a received slave address is not acknowledged, further slave events will be ignored until the next START is detected.

24.4.4.2. Hardware ACK Generation

When the EHACK bit in register SMB0ADM is set to 1, automatic slave address recognition and ACK generation is enabled. More detail about automatic slave address recognition can be found in Section 24.4.5. As a receiver, the value currently specified by the ACK bit will be automatically sent on the bus during the ACK cycle of an incoming data byte. As a transmitter, reading the ACK bit indicates the value received on the last ACK cycle. The ACKRQ bit is not used when hardware ACK generation is enabled. If a received slave address is NACKed by hardware, further slave events will be ignored until the next START is detected, and no interrupt will be generated.

Table 24.3 lists all sources for hardware changes to the SMB0CN bits. Refer to Table 24.5 for SMBus status decoding using the SMB0CN register.

Table 24.3. Sources for Hardware Changes to SMB0CN

Bit	Set by Hardware When:	Cleared by Hardware When:
MASTER	■ A START is generated.	■ A STOP is generated. ■ Arbitration is lost.
TXMODE	■ START is generated. ■ SMB0DAT is written before the start of an SMBus frame.	■ A START is detected. ■ Arbitration is lost. ■ SMB0DAT is not written before the start of an SMBus frame.
STA	■ A START followed by an address byte is received.	■ Must be cleared by software.
STO	■ A STOP is detected while addressed as a slave. ■ Arbitration is lost due to a detected STOP.	■ A pending STOP is generated.

26. Universal Asynchronous Receiver/Transmitter (UART0)

UART0 is an asynchronous, full duplex serial port offering modes 1 and 3 of the standard 8051 UART. Enhanced baud rate support allows a wide range of clock sources to generate standard baud rates (details in Section “26.1. Enhanced Baud Rate Generation” on page 289). Received data buffering allows UART0 to start reception of a second incoming data byte before software has finished reading the previous data byte.

UART0 has two associated SFRs: Serial Control Register 0 (SCON0) and Serial Data Buffer 0 (SBUF0). The single SBUF0 location provides access to both transmit and receive registers. **Writes to SBUF0 always access the transmit register. Reads of SBUF0 always access the buffered receive register; it is not possible to read data from the transmit register.**

With UART0 interrupts enabled, an interrupt is generated each time a transmit is completed (TI is set in SCON0), or a data byte has been received (RI is set in SCON0). The UART0 interrupt flags are not cleared by hardware when the CPU vectors to the interrupt service routine. They must be cleared manually by software, allowing software to determine the cause of the UART0 interrupt (transmit complete or receive complete).

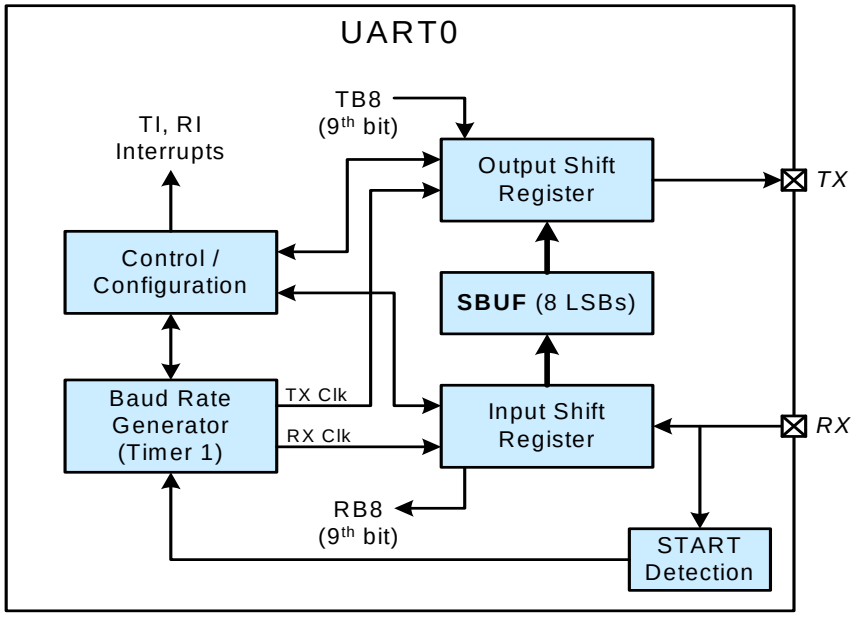

Figure 26.1. UART0 Block Diagram

26.1. Enhanced Baud Rate Generation

The UART0 baud rate is generated by Timer 1 in 8-bit auto-reload mode. The TX clock is generated by TL1; the RX clock is generated by a copy of TL1 (shown as RX Timer in Figure 26.2), which is not user-accessible. Both TX and RX Timer overflows are divided by two to generate the TX and RX baud rates. The RX Timer runs when Timer 1 is enabled, and uses the same reload value (TH1). However, an RX Timer reload is forced when a START condition is detected on the RX pin. This allows a receive to begin any time a START is detected, independent of the TX Timer state.

29.2. C2 Interface Registers

The following describes the C2 registers necessary to perform flash programming through the C2 interface. All C2 registers are accessed through the C2 interface, and are not available in the SFR map for firmware access.

Register 29.1. C2ADD: C2 Address

Bit	7	6	5	4	3	2	1	0
Name	C2ADD							
Type	RW							
Reset	0	0	0	0	0	0	0	0
This register is part of the C2 protocol.								

Table 29.1. C2ADD Register Bit Descriptions

Bit	Name	Function
7:0	C2ADD	**C2 Address.** The C2ADD register is accessed via the C2 interface. The value written to C2ADD selects the target data register for C2 Data Read and Data Write commands. 0x00: C2DEVID 0x01: C2REVID 0x02: C2FPCTL 0xB4: C2FPDAT